

## CLAIMS

1. A curable composition comprising

(A) 100 parts by weight of a reactive silicon group-containing polyoxypropylene polymer,

(B) from 0.1 to 20 parts by weight of a silane coupling agent,

(C) from 0.1 to 80 parts by weight of an epoxy group-containing compound,

(D) from 0.1 to 60 parts by weight of a tertiary amine, and

(E) from 0.1 to 30 parts by weight of a primary or secondary amine having a melting point of 20°C or more.

2. A two-component curable composition comprising agent A comprising

(A) x parts by weight of a reactive silicon group-containing polyoxypropylene polymer,

(B) from 0.1 to 20 parts by weight of a silane coupling agent,

(D) from 0.1 to 60 parts by weight of a tertiary amine, and

(E) from 0.1 to 30 parts by weight of a primary or secondary amine having a melting point of 20°C or more (provided  $0 < x \leq 100$ ), and agent B comprising

(A) 100-x parts by weight of the reactive silicon group-containing polyoxypropylene polymer,

(C) from 0.1 to 80 parts by weight of an epoxy group-containing compound, and

(F) from 0.1 to 5 parts by weight of water.

3. The curable composition as claimed in claim 1 or 2, wherein the viscosity of the composition is at least 50 Pa·s and at most 200 Pa·s at 23°C, and the structural viscosity index thereof is at least 4.0 and at most 10.

4. The curable composition as claimed in any of claims 1 to 3, which further comprises

(G) from 50 to 300 parts by weight of an inorganic filler.

5. The curable composition as claimed in any of claims 1 to 4, wherein component (E) is a primary amine.

6. A coating material comprising the curable composition as claimed in any of claims 1 to 5.